



Our Mission

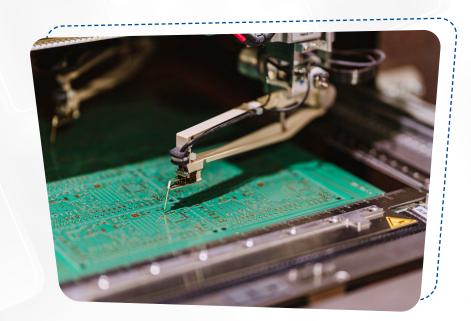
Printed circuit boards which we offer are the core of our Clients production. We gain satisfaction from developing custom-made, high quality products.



Our Vision

We value time and money. Our aim is to deliver products as soon as our Clients need them.

We have achieved success by regular optimisation of operational costs.



Our localisation



Production area approx. 3750 m²



Office area approx. 727,44 m²

TS PCB

Benzynowa St. 21 83-011 Gdańsk





Techno-Service S.A. includes:

TS PCB

PCB production

established in 1984

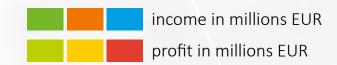
LABORATORY OF ENVIRONMENTAL PROTECTION

Research and evaluation of harmful health factors in the work environment.

established in 1982



Techno-Service S.A. income-profit in 2016-2022





TS PCB team













3 people

Quality management 6 people

Customer Service Office 4 people

CAM support

7 people

CAM engineers

97 people

Manufacturing Plant

Our team

120 people



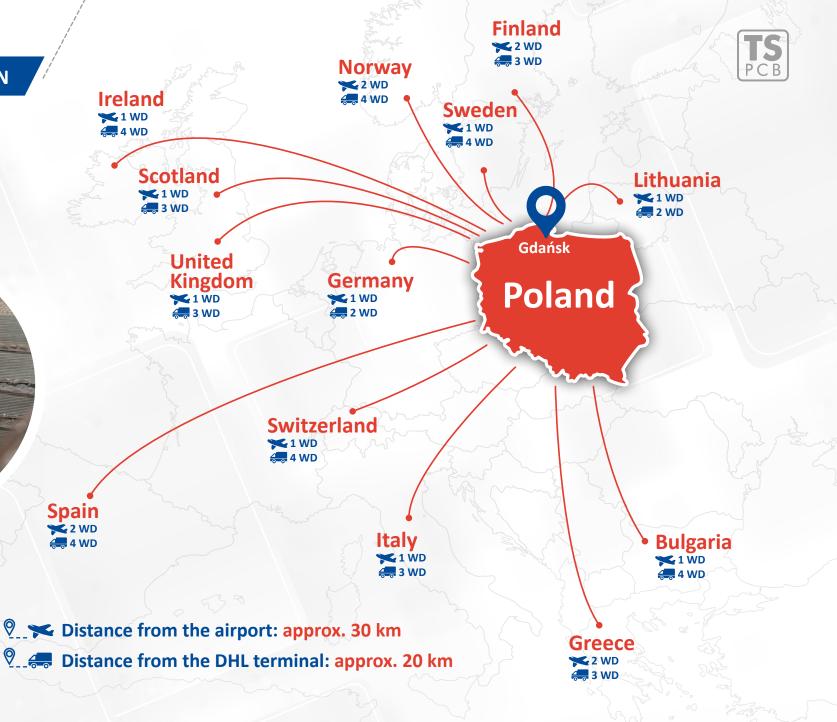


Shipping time



TS PCB

Benzynowa St. 21 83-011 Gdańsk



EXPERIENCE



Over 35 years of market experience











Beginnings as student activities (such as production of hulahoop wheels, elastic ties, management of students' dinners).

1984

Establishment of PCB manufacturing service (now TS PCB).

1992

Techno-Service becomes joint-stock company.

1998

Manufacturing plant moves to new buildings at Benzynowa Street in Gdańsk.



2014-2018

Machine park expansion and new machines purchase, for e.g. LEDIA Direct Imaging System, two ATG A5 Neo testers. 2019

Opening of the new part of the plant.



16.03.1984

Production of the very first PCB called "voltage regulator".





TECHNOLOGY





PCB types:

Single-sided PCB

- FR-4,
- ALU MCPCB,
- Rogers.

Double-sided PCB

- FR-4,
- Rogers.

Multilayer PCB

• FR-4 (up to 8-layers).

• FR-4

material thickness: 0.2 to 3.2 mm,

Base materials:

- TG values: 135 (standard), 150 (IS400), 180 (IS410),
- copper thickness:
 18 (single-sided) to 240 μm,
- CTI: PLCO to PLC3 (standard),
- IPC class: 2 (standard), 3.

ALU MCPCB

- single-sided PCBs without vias plating,
- material thickness: 0.8 to 3.2 mm,
- thermal conductivity: 1.3 to 5 W/mK,
- copper thickness: 35 to 105 μm.

Rogers

- single-sided PCB for RO3000 series,
- single- and double-sided PCB for RO4000 series.

Technical highlights:

- surface finish: ENIG, LF HASL,
- blind and buried vias,
- plugged vias,
- colored soldermasks and silkscreen layers,
- depth routing, plated edges and sinkholes, castellated holes, peelable mask,
- certificates: UL ZPMV2 94V-0, IK Polish Railway Institute, PPAP documentation,
- advanced technology:
 - minimal clearance: 3 mils,
 - minimal annular ring: 4 mils,
 - minimal finished plated hole size: 0.15 mm.

TS PCB

TECHNOLOGY



PARAMETER	DESCRIPTION		
Number of layers	1 to 8		
Max. PCB dimensions	463.0 x 576.0 mm for 1- and 2-layer PCB	421.0 x 573.4 mm for multilayer PCB	
Min. PCB dimensions	5 x 5 mm (up to 30 x 30 mm PCB must be panelised)		
Base materials	ALU MCPCB; FR4 TG135°C to 180°C, CTI PLC0 to PLC3, Isola 370HR; Rogers RO3000 and RO4000 series		
Base material thickness: single and double-sided	0.2 to 3.2 mm		
Copper thickness	12 μm / 1/3 oz * 18 μm / 1/2 oz 35 μm / 1 oz 70 μm / 2 oz	105 μm / 3 oz 140 μm / 4 oz 175 μm / 5 oz 210 μm / 6 oz	
Prepregs	106; 1080; 2116; 7628		
Blind and buried vias limits	blind via min Ø=0.15 mm, Aspect Ratio 1:1.2 (drilled), buried via min Ø=0.15 mm		
Min. track width outer layer	0.100 mm / 4 mils (max 18 μm base Cu) 0.075 mm / 3 mils (max 12 μm base Cu) *		
Min. spacing outer layer	0.100 mm / 4 mils (max 18 μm base Cu) 0.075 mm / 3 mils (max 12 μm base Cu) *		
Min. annular ring outer layer	0.125 mm / 5 mils 0.100 mm / 4 mils *		
Min. track width inner layer	0.100 mm / 4 mils (max 18 μm base Cu) 0.075 mm / 3 mils (max 12 μm base Cu) *		
Min. spacing inner layer	0.100 mm / 4 mils (max 18 μm base Cu) 0.075mm / 3 mils (max 12 μm base Cu) *		
Min. finished plated hole size	0.15 mm / 6 mils		
Min. outer layer pad diameter	0.25 mm / 10 mils 0.20 mm / 8 mils * } + selected finished hole size		

^{*} advanced technology

TS PCB

TECHNOLOGY



PARAMETER	DESCRIPTION		
Min. annular ring inner layer	4-layer PCB	6-layer PCB	8-layer PCB
	0.125 mm / 5 mils 0.100 mm / 4 mils *	0.150 mm / 6 mils 0.125 mm / 5 mils *	0.175 mm / 7 mils 0.125 mm / 5 mils *
Min. inner layer pad diameter	0.25 mm / 10 mils 0.20 mm / 8 mils *	0.30 mm / 12 mils 0.25 mm / 10 mils *	0.35 mm / 14 mils 0.25 mm / 10 mils *
	+ selected finished hole size		
Min. Cu to board edge clearance (for 1.55 mm FR4 material)	Routing: 0.2 mm, V-cut: 0.4 mm		
Surface finish	ENIG, LF HASL		
Soldermask color	green (standard), black, blue, red, white, yellow		
Soldermask clearance	0.05 mm / 2.0 mils 0.01 mm / 0.5 mils *		
Solder bridge	0.075 mm / 3 mils		
Milling tolerance	± 0.10 mm ± 0.05 mm *		
Legend color	white (standard), black, blue, green, red, yellow		
Extra options	blind vias; buried vias; peelable mask; via filling IPC 4761 type III and IV; depth routing; plated edges and sinkholes; castellated holes		
Min. slots and cut-outs	0.5 mm		

^{*} advanced technology

OFFER





TSka Prototype

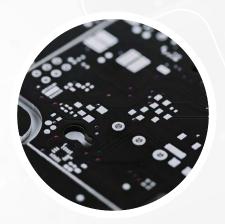
Fast production and low-cost prototypes on 1 mm and 1.55 mm FR4 laminates.

Production batch

Advanced technology, fast delivery.

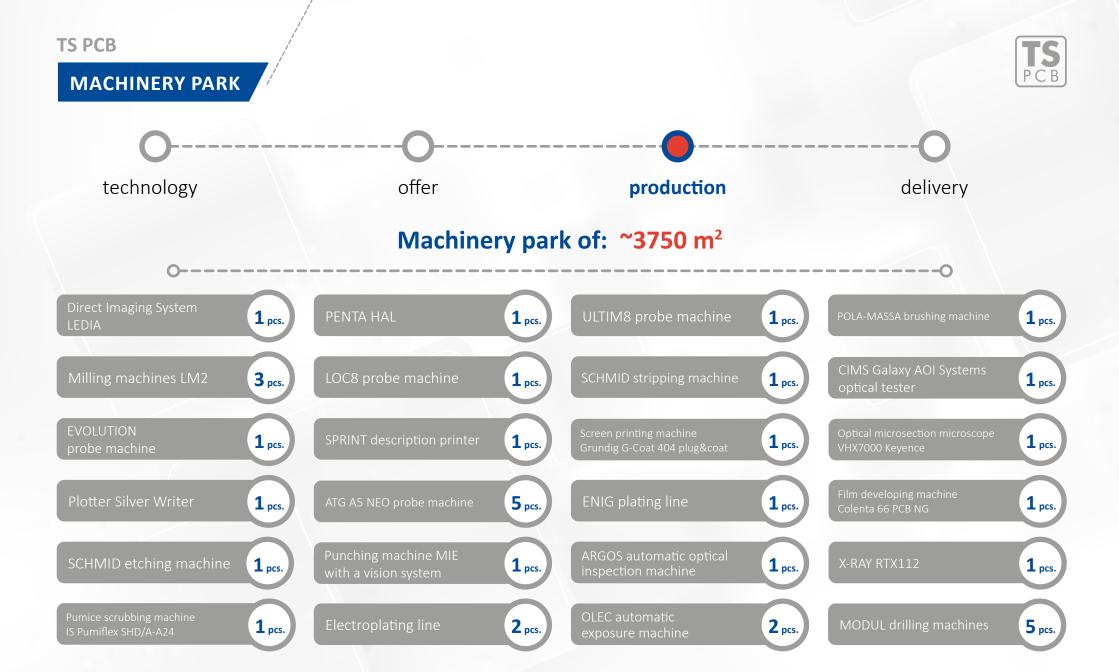
5LT

Possibility of online ordering with the surface between 1 and 5 m² with the lead time of 5 WD.









Our machine park already has over 200 machines and is still growing

MACHINERY PARK







Ledia 5S

- machine for direct copper and soldermask layers exposure with UV-LED,
- direct print of copper and soldermask images without use of film.



Drills Modul

- maintenance-free linear motors XY with 80 m/min – guarantees high productivity,
- · high speed drilling spindles up to 250 krpm,
- toolchain for 2200 tools and intelligent tool management.



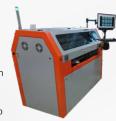
OLEC exposure lamp

- process include: inner layer, outer layer, soldermask,
- data collection and real time registration feedback.
- · process tolerance control,
- dual trays for optimized production.



Sprint 200 printer

- cost-effective, top quality industrial inkjet printing for a consistently accurate production of even the most advanced legend designs in DotStream Pro Technology,
- advanced LED-based UV for a perfect ink drop pinning on-the-fly.



Tester A5 Neo

- tester has 8 fast moving measuring probes (flying probes) for testing printed circuits with use of the resistance, capacitance and mixed method,
- the production format is located in the draw and tested in the horizontal orientation.



SCM 411 scoring machine

- 2 moving cutters for linear cutting of the printed circuits surface,
- measuring system that uses integrated camera, which enables automatic reference positioning of the mechanical system for circuit diagrams.

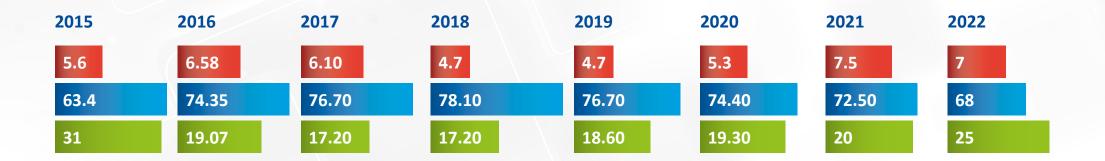
PRODUCTION





Single-sided, double-sided and multilayer PCB production in 2015 - 2022

(% of total sale)





Single-sided PCB (including ALUMINIUM laminate)



Double-sided PCB

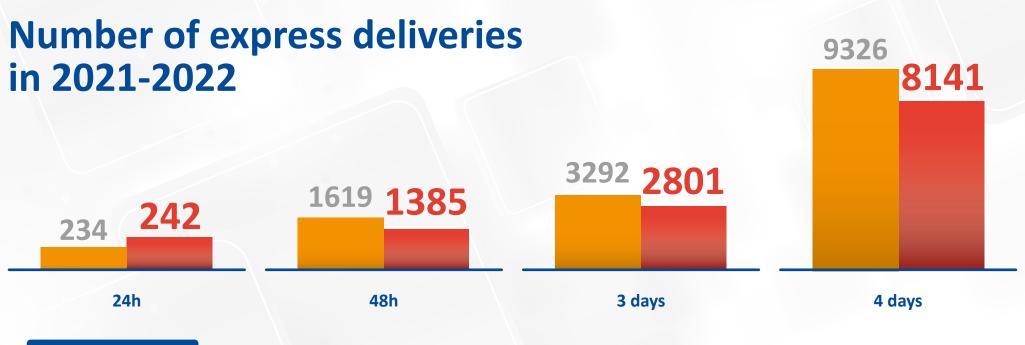


Multilayer PCB

PRODUCTION







Standard delivery:

Production batch

9 days - single- and double-sided PCB,

10 days - multilayer PCB.

TSka prototypes

7 days - single- and double-sided PCB,

9 days - multilayer PCB.



INDUSTRIES



Solid Client Base











Rail



Automotive



Army



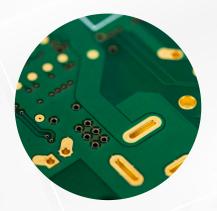
Telecommunication and data transmission

We cooperate

with over 800 business partners.

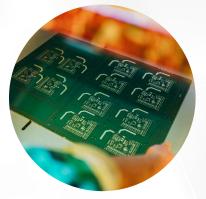
OUR VALUES













Experience

Quality

Customer-oriented approach

Production

Expert knowledge

Over 35 years of market experience

Advanced Technology Flexibility in customer service

Constant investments in machinery park

Technical client support

OUR VALUES



Pro Client values

- Support during end-to-end production process,
- fast offers,
- express delivery terms,
- complex services based on cooperation with EMS companies,
- on-line service:
 - prototypes calculator,
 - client account on website,
 - client order tracking.

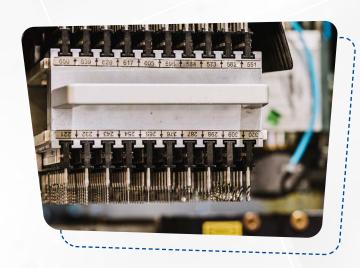


OUR VALUES



Production values

- Constant production optimisation (processes and products quality supervision),
- Quality management system
 ISO 9001:2015, ISO 14001:2015.





Certificate ISO 9001:2015 ISO 14001:2015.



Flammability certificate UL

- Underwriters Laboratories Inc., USA.



Flammability IK Polish Railway Institute Report.

We are members of:



IPC - Association Connecting Electronics Industries



FED - Fachverband fur Design, Leiterplatten & Elektronikfertigung

EXPERT KNOWLEDGE





We support our clients at each and every stage of order realisation

(Customer Service Office and CAM support).

IN NUMBERS











120 people

~3750 m²

3000 m²

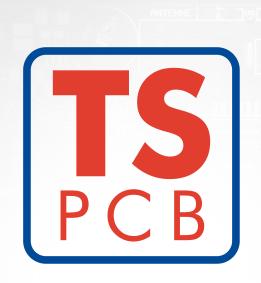
24128

Our team

Machinery park

Production capacity in 1 month

Number of express deliveries in 2022



Thank you!

www.tspcb.pl/en